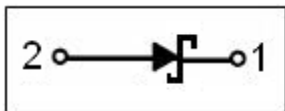


/ Descriptions

/ Features

/ Applications

/ Equivalent Circuit



/ Pinning



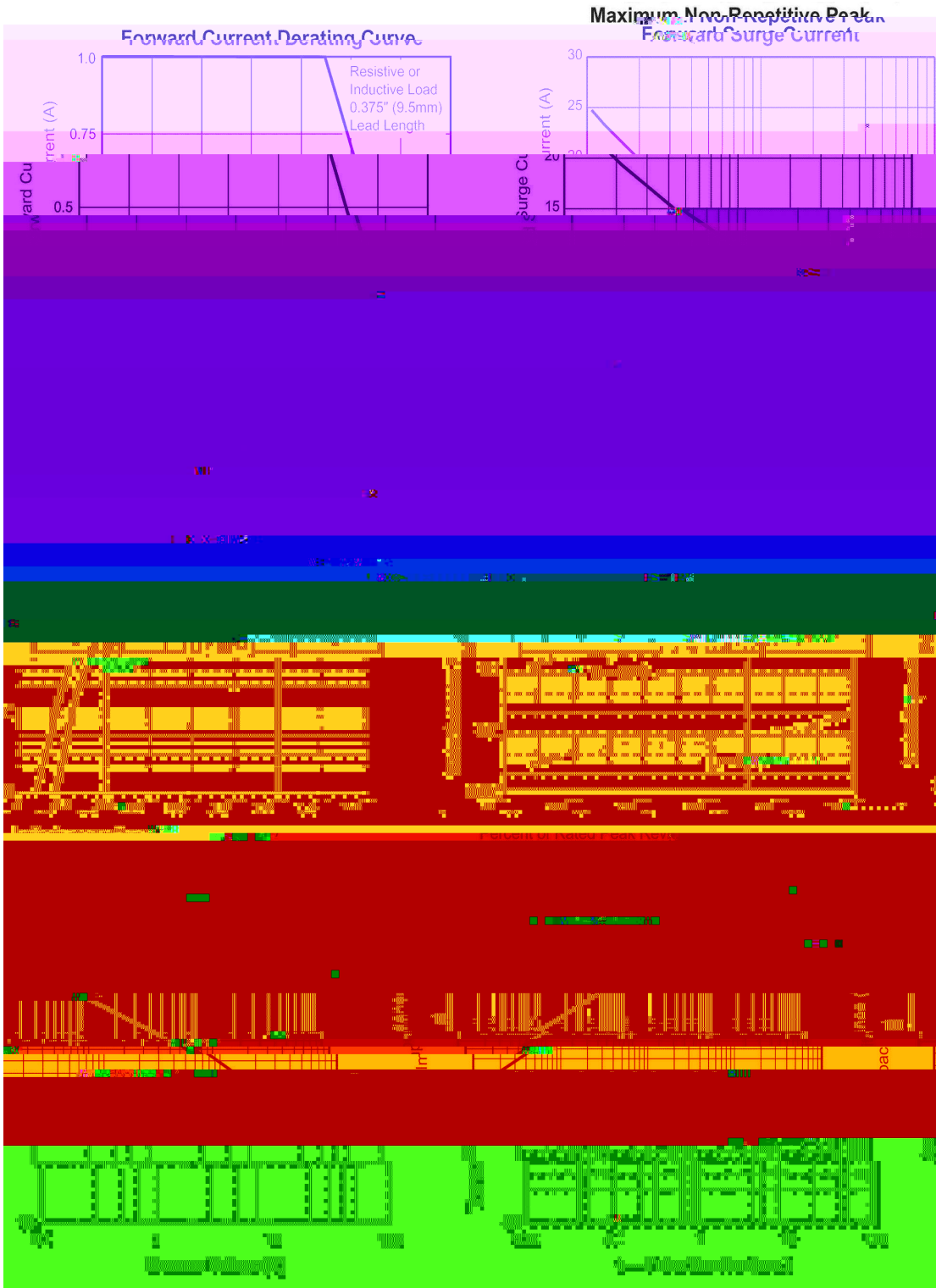
/ h_{FE} Classifications & Marking

/ Absolute Maximum Ratings(Ta=25)

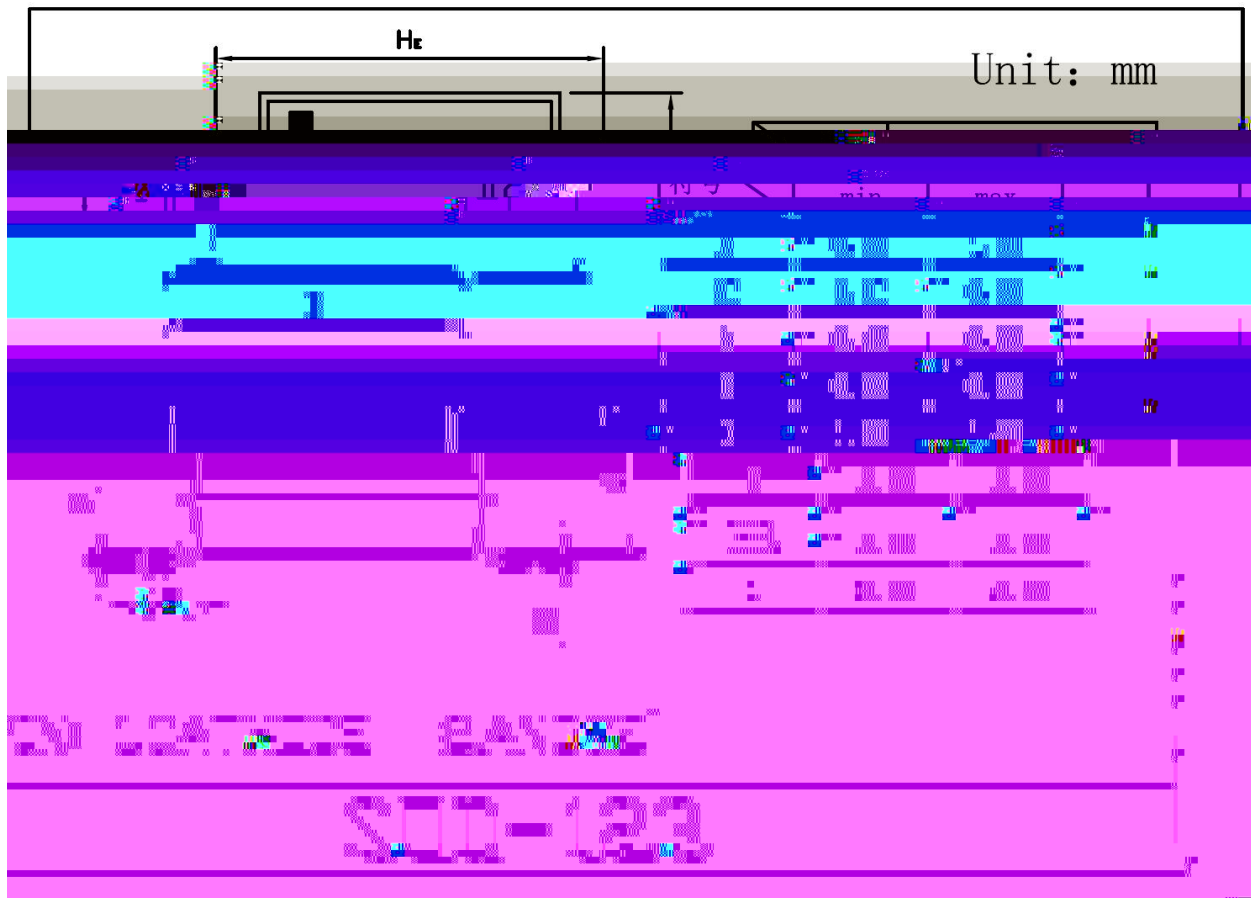
	()				
					°C
					°C

/ Electrical Characteristics(Ta=25)

/ Electrical Characteristic Curve



/ Package Dimensions

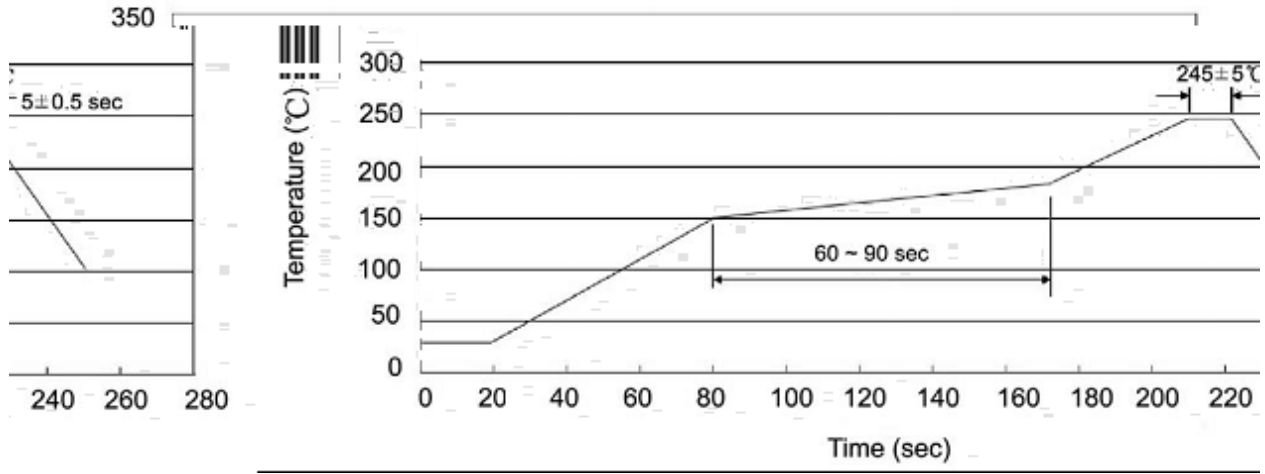


/ Marking Instructions



H
SJ

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± ± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只卷盘	卷盘盒	只盒	盒箱	只箱	盒	箱	
						"		

/ Notices